# Low voltage high bandwidth quad DPDT switch 

## Datasheet - production data



## Features

- Ultralow power dissipation
- $\mathrm{I}_{\mathrm{CC}}=1 \mu \mathrm{~A}$ (max.) at $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$
- Low "ON" resistance
- $\mathrm{R}_{\mathrm{ON}}=5.4 \Omega\left(\mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)$ at $\mathrm{V}_{\mathrm{CC}}=4.3 \mathrm{~V}$
- $\mathrm{R}_{\mathrm{ON}}=6.6 \Omega\left(\mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)$ at $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$
- Wide operating voltage range
$-\mathrm{V}_{\mathrm{CC}}$ (OPR.) $=1.65 \mathrm{~V}$ to 4.3 V
- 4.3 V tolerant and 1.8 V compatible threshold on digital control input at $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$ to 3.0 V
- 4 select pins controlling 2 switches each
- Typical bandwidth $(-3 \mathrm{~dB})$ at 800 MHz on all channels
- USB (2.0) high speed (480 Mbps) signal switching compliant
- Integrated fail safe function
- Latch-up performance exceeds 100 mA per JESD 78, Class II
- ESD performance exceeds JESD22 2000-V human body model (A114-A)


## Description

The STG3820 device is a high-speed CMOS low voltage quad analog DPDT (dual pole dual throw) switch or 2:1 multiplexer/demultiplexer switch fabricated in silicon gate $\mathrm{C}^{2}$ MOS technology. It is designed to operate from 1.65 V to 4.3 V , making this device ideal for portable applications.

The SELm-n input is provided to control the switches. The switches nS 1 and mS 1 are ON (connected to common ports Dn and Dm respectively) when the SELm-n input is held high and OFF (high impedance state exists between the two ports) when the SELm-n is held low. The switches nS 2 and mS 2 are ON (connected to common port Dn and Dm respectively) when the SELm-n input is held low and OFF (high impedance state exists between the two ports) when the SELm-n is held high.
The STG3820 device has an integrated fail safe function to withstand overvoltage condition when the device is powered off. Additional key features are fast switching speed, break-before-makedelay time and ultralow power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Table 1. Device summary

| Order code | Package | Packing |
| :---: | :---: | :---: |
| STG3820BJR | Flip Chip 30 <br> $(2.0 \times 2.4 \mathrm{~mm})$ | Tape and reel |

## Applications

- Mobile phones


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## 1 <br> Pin settings

### 1.1 Pin connection

Figure 1. Pin connection


### 1.2 Pin description

Table 2. Pin assignment

| Pin number | Symbol | Name and function |
| :---: | :---: | :--- |
| A1 | 1S1 | Independent channel for switch 1 |
| A2 | D1 | Common channel for switch 1 |
| A3 | 1 S2 | Independent channel for switch 1 |
| A4 | 5 S2 | Independent channel for switch 5 |
| A5 | D5 | Common channel for switch 5 |
| A6 | 5 S1 | Independent channel for switch 5 |
| B1 | 2 S1 | Independent channel for switch 2 |
| B2 | D2 | Common channel for switch 2 |
| B3 | 2 S2 | Independent channel for switch 2 |
| B4 | $6 S 2$ | Independent channel for switch 6 |
| B5 | D6 | Common channel for switch 6 |
| B6 | $6 S 1$ | Independent channel for switch 6 |

Table 2. Pin assignment (continued)

| Pin number | Symbol | Name and function |
| :---: | :---: | :--- |
| C1 | SEL1-2 | Switch 1-2 selection control |
| C2 | VCC | Positive supply voltage |
| C3 | SEL3-4 | Switch 3-4 selection control |
| C4 | SEL5-6 | Switch 5-6 selection control |
| C5 | GND | Ground (0 V) |
| C6 | SEL7-8 | Switch 7-8 selection control |
| D1 | 3S1 | Independent channel for switch 3 |
| D2 | D3 | Common channel for switch 3 |
| D3 | 3S2 | Independent channel for switch 3 |
| D4 | 7S2 | Independent channel for switch 7 |
| D5 | D7 | Common channel for switch 7 |
| D6 | 7S1 | Independent channel for switch 7 |
| E1 | 4 S1 | Independent channel for switch 4 |
| E2 | D4 | Common channel for switch 4 |
| E3 | 4 S2 | Independent channel for switch 4 |
| E4 | 8 82 | Independent channel for switch 8 |
| E5 | D8 | Common channel for switch 8 |
| E6 | 8 81 | Independent channel for switch 8 |

## 2 Logic diagram

Figure 2. Logic equivalent circuit


Table 3. Truth table

| SEL | Switch nS1 | Switch ns2 |
| :---: | :---: | :---: |
| H | ON | OFF $^{(1)}$ |
| L | OFF $^{(1)}$ | ON |

1. High impedance.

## 3 Maximum ratings

Stressing the device above the rating listed in Table 4: Absolute maximum ratings may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in Table 5: Recommended operating conditions of this specification is not implied. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

Table 4. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | -0.5 to 6.0 | V |
| $V_{1}$ | DC input voltage | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $V_{\text {IC }}$ | DC control input voltage | -0.5 to 5.5 | V |
| $\mathrm{V}_{\mathrm{O}}$ | DC output voltage | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{I}_{\text {IKC }}$ | DC input diode current on control pin ( $\mathrm{V}_{\text {SEL }}<0 \mathrm{~V}$ ) | -50 | mA |
| $\mathrm{I}_{\mathrm{IK}}$ | DC input diode current ( $\mathrm{V}_{\text {SEL }}<0 \mathrm{~V}$ ) | $\pm 50$ | mA |
| lok | DC output diode current | $\pm 20$ | mA |
| $\mathrm{I}_{0}$ | DC output current | $\pm 128$ | mA |
| IOP | DC output current peak (pulse at $1 \mathrm{~ms}, 10 \%$ duty cycle) | $\pm 300$ | mA |
| $\mathrm{I}_{\text {CC }}$ or $\mathrm{I}_{\text {GND }}$ | DC $V_{\text {CC }}$ or ground current | $\pm 100$ | mA |
| $P_{\text {D }}$ | Power dissipation at $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ | 1120 | mW |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead temperature (10 sec.) | 300 | ${ }^{\circ} \mathrm{C}$ |

## Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage | 1.65 to 4.3 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | Input voltage | 0 to $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{IC}}$ | Control input voltage | 0 to 4.3 | V |
| $\mathrm{~V}_{\mathrm{O}}$ | Output voltage | 0 to $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\mathrm{op}}$ | Operating temperature | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{dt} / \mathrm{dv}$ | Input rise and fall time control <br> input | $\mathrm{V}_{\mathrm{L}}=1.65 \mathrm{~V}$ to 2.7 V | 0 to 20 |
|  | $\mathrm{~V} / \mathrm{ns} / \mathrm{V}$ |  |  |

## 4 Electrical characteristics

Table 6. DC specifications

| Symbol | Parameter | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | Test conditions | Value |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -40 to $85{ }^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  | Min. | Typ. | Max. | Min. | Max. |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High level input voltage | 1.65-1.95 |  | $\begin{aligned} & 0.65 \\ & V_{C C} \end{aligned}$ | - | - | $\begin{aligned} & 0.65 \\ & V_{C C} \end{aligned}$ | - | V |
|  |  | 2.3-2.5 |  | 1.2 | - | - | 1.2 | - |  |
|  |  | 2.7-3.0 |  | 1.3 | - | - | 1.3 | - |  |
|  |  | 3.3-3.6 |  | 1.4 | - | - | 1.4 | - |  |
|  |  | 4.3 |  | 1.6 | - | - | 1.6 | - |  |
| $\mathrm{V}_{\text {IL }}$ | Low level input voltage | 1.65-1.95 |  | - | - | 0.25 | - | 0.25 | V |
|  |  | 2.3-2.5 |  | - | - | 0.25 | - | 0.25 |  |
|  |  | 2.7-3.0 |  | - | - | 0.25 | - | 0.25 |  |
|  |  | 3.3-3.6 |  | - | - | 0.30 | - | 0.30 |  |
|  |  | 4.3 |  | - | - | 0.40 | - | 0.40 |  |
| $\mathrm{R}_{\text {PEAK }}$ | Switch ON peak resistance | 1.8 | $\begin{gathered} \mathrm{V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}} \\ \mathrm{I}_{\mathrm{S}}=8 \mathrm{~mA} \end{gathered}$ | - | 17.0 | 19.6 | - | - | $\Omega$ |
|  |  | 2.7 |  | - | 7.5 | 8.7 | - | - |  |
|  |  | 3.0 |  | - | 6.6 | 7.6 | - | - |  |
|  |  | 3.7 |  | - | 5.8 | 6.7 | - | - |  |
|  |  | 4.3 |  | - | 5.4 | 6.2 | - | - |  |
| $\mathrm{R}_{\mathrm{ON}}$ | Switch ON resistance | 3.0 | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=3 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{S}}=8 \mathrm{~mA} \end{aligned}$ | - | 5.1 | 5.8 | - | - | $\Omega$ |
|  |  | 3.0 | $\begin{aligned} \mathrm{V}_{\mathrm{S}} & =0.4 \mathrm{~V} \\ \mathrm{I}_{\mathrm{S}} & =8 \mathrm{~mA} \end{aligned}$ | - | 6.3 | 7.3 | - | - |  |
| $\Delta \mathrm{R}_{\mathrm{ON}}$ | ON resistance match between channels ${ }^{(1)}$ | 1.8 | $\begin{gathered} \mathrm{V}_{\mathrm{S}} \text { at } \mathrm{R}_{\mathrm{ON}} \mathrm{MAX} \\ \mathrm{I}_{\mathrm{S}}=8 \mathrm{~mA} \end{gathered}$ | - | - | - | - | - | $\Omega$ |
|  |  | 2.7 |  | - | - | - | - | - |  |
|  |  | 3.0 |  | - | 0.3 | - | - | - |  |
|  |  | 3.7 |  | - | - | - | - | - |  |
|  |  | 4.3 |  | - | - | - | - | - |  |

Table 6. DC specifications (continued)

| Symbol | Parameter | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | Test conditions | Value |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -40 to $85{ }^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  | Min. | Typ. | Max. | Min. | Max. |  |
| $\mathrm{R}_{\text {FLAT }}$ | ON resistance flatness ${ }^{(2)}$ | 1.8 | $\begin{gathered} \hline \mathrm{V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \\ 0.4 \mathrm{~V} \\ \mathrm{I}_{\mathrm{S}}=8 \mathrm{~mA} \end{gathered}$ | - | 4.5 | - | - | - | $\Omega$ |
|  |  | 1.8 | $\begin{gathered} \mathrm{V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}} \\ \mathrm{I}_{\mathrm{S}}=8 \mathrm{~mA} \end{gathered}$ | - | 9.5 | - | - | - |  |
|  |  | 2.7 |  | - | 2.2 | - | - | - |  |
|  |  | 3.0 |  | - | 1.8 | - | - | - |  |
|  |  | 3.7 |  | - | 1.6 | - | - | - |  |
|  |  | 4.3 |  | - | 1.6 | - | - | - |  |
| IOFF | OFF state leakage current (Sn), (D) | 4.3 | $\mathrm{V}_{\mathrm{S}}=0.3$ or 4 V | -20 | - | 20 | -100 | 100 | nA |
| $\mathrm{I}_{\mathrm{N}}$ | Input leakage current | 0 to 4.3 | $\begin{gathered} \mathrm{V}_{\mathrm{SEL}}=0 \text { to } \\ 4.3 \mathrm{~V} \end{gathered}$ | -0.2 | - | 0.2 | -1.0 | 1.0 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{Cc}}$ | Quiescent supply current | 1.65 to 4.3 | $V_{S E L}=V_{C C} \text { or }$ GND | -0.2 | - | 0.2 | -1.0 | 1.0 | $\mu \mathrm{A}$ |
| ICCLV | Quiescent supply current for low voltage driving ${ }^{(3)}$ | 4.3 | $\mathrm{V}_{\mathrm{SEL}}=1.65 \mathrm{~V}$ | - | $\pm 37$ | $\pm 50$ | - | $\pm 100$ | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{SEL}}=1.80 \mathrm{~V}$ | - | $\pm 33$ | $\pm 40$ | - | $\pm 50$ |  |
|  |  |  | $\mathrm{V}_{\text {SEL }}=2.60 \mathrm{~V}$ | - | $\pm 11$ | $\pm 20$ | - | $\pm 30$ |  |

1. $\Delta R_{\mathrm{ON}}=\max .|\mathrm{mSN}-\mathrm{nSN}|$, where $\mathrm{m}=1$ to 8 and $\mathrm{n}=1$ to $8, \mathrm{~N}=1,2$.
2. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
3. Measurement is for one SEL pin.

Table 7. AC electrical characteristics ( $\left.C_{L}=35 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}} \leq 5 \mathrm{~ns}\right)$

| Symbol | Parameter | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | Test conditions | Value |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -40 to $85{ }^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  | Min. | Typ. | Max. | Min. | Max. |  |
| $t_{\text {PLH, }}{ }^{\text {t }}$ PHL | Propagation delay | 1.65-1.95 |  | - | 0.21 | - | - | - | ns |
|  |  | 2.3-2.7 |  | - | 0.15 | - | - | - |  |
|  |  | 3.0-3.3 |  | - | 0.14 | - | - | - |  |
|  |  | 3.6-4.3 |  | - | 0.13 | - | - | - |  |
| $\mathrm{t}_{\mathrm{ON}}$ | Turn-on time | 1.65-1.95 | $\mathrm{V}_{\mathrm{S}}=0.8 \mathrm{~V}$ | - | 36 | - | - | - | ns |
|  |  | 2.3-2.7 | $\mathrm{V}_{\mathrm{S}}=1.5 \mathrm{~V}$ | - | 20 | 23 | - | 26 |  |
|  |  | 3.0-3.3 |  | - | 15 | 17 | - | 20 |  |
|  |  | 3.6-4.3 |  | - | 13 | 15 | - | 17 |  |
| $\mathrm{t}_{\text {OFF }}$ | Turn-off time | 1.65-1.95 | $\mathrm{V}_{\mathrm{S}}=0.8 \mathrm{~V}$ | - | 29 | - | - | - | ns |
|  |  | 2.3-2.7 | $\mathrm{V}_{\mathrm{S}}=1.5 \mathrm{~V}$ | - | 19 | 22 | - | 25 |  |
|  |  | 3.0-3.3 |  | - | 14 | 16 | - | 18 |  |
|  |  | 3.6-4.3 |  | - | 11 | 13 | - | 14 |  |
| $t_{D}$ | Break-beforemake time delay | 1.65-1.95 | $\begin{aligned} C_{L} & =35 \mathrm{pF} \\ R_{L} & =50 \Omega \\ V_{S} & =1.5 \mathrm{~V} \end{aligned}$ | - | 10 | - | - | - | ns |
|  |  | 2.3-2.7 |  | - | 7 | - | - | - |  |
|  |  | 3.0-3.3 |  | - | 6 | - | - | - |  |
|  |  | 3.6-4.3 |  | - | 4 | - | - | - |  |
| Q | Charge injection | 1.65 | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF} \\ & \mathrm{~V}_{\mathrm{GEN}}=0 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{GEN}}=0 \Omega \end{aligned}$ | - | 3.9 | - | - | - | pC |
|  |  | 2.3 |  | - | 4.8 | - | - | - |  |
|  |  | 3.0 |  | - | 5.2 | - | - | - |  |
|  |  | 4.3 |  | - | 6.4 | - | - | - |  |

Table 8. AC electrical characteristics ( $C_{L}=5 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| Symbol | Parameter | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | Test conditions | Value |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -40 to $85{ }^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  | Min. | Typ. | Max. | Min. | Max. |  |
| OIRR | OFF isolation ${ }^{(1)}$ | 1.65-4.3 | $\begin{gathered} V_{S}=1 \mathrm{~V}_{\mathrm{RMS}}, \\ \mathrm{f}=1 \mathrm{MHz} \\ \text { signal }=0 \mathrm{dBm} \end{gathered}$ | - | -78 | - | - | - | dB |
|  |  |  | $\begin{gathered} V_{S}=1 V_{R M S} \\ f=10 \mathrm{MHz} \\ \text { signal }=0 \mathrm{dBm} \end{gathered}$ | - | -57 | - | - | - |  |
| Xtalk | Crosstalk | 1.65-4.3 | $\begin{gathered} V_{S}=1 \mathrm{~V}_{\mathrm{RMS}}, \\ \mathrm{f}=1 \mathrm{MHz} \\ \text { signal }=0 \mathrm{dBm} \end{gathered}$ | - | -78 | - | - | - | dB |
|  |  |  | $\begin{gathered} V_{S}=1 V_{R M S}, \\ f=10 \mathrm{MHz} \\ \text { signal }=0 \mathrm{dBm} \end{gathered}$ | - | -58 | - | - | - |  |
| BW | -3dB bandwidth | $3.0-4.3$ | $\begin{gathered} R_{\mathrm{L}}=50 \Omega \\ \text { signal }=0 \mathrm{dBm} \end{gathered}$ | - | 800 | - | - | - | MHz |
| $\mathrm{C}_{\text {IN }}$ | Control pin input capacitance |  | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ | - | 2 | - | - | - | pF |
| $\mathrm{C}_{\text {Sn }}$ | Sn port capacitance | 3.3 | $\mathrm{F}=240 \mathrm{MHz},$ <br> switch is enabled | - | 6 | - | - | - | pF |
|  |  |  | $\mathrm{F}=240 \mathrm{MHz},$ <br> switch is disabled | - | 2 | - | - | - |  |
| $\mathrm{C}_{\mathrm{D}}$ | D port capacitance | 3.3 | $\mathrm{F}=240 \mathrm{MHz}$ | - | 8 | - | - | - | pF |

1. Off isolation $=20 \log 10\left(\mathrm{~V}_{\mathrm{D}} / \mathrm{V}_{\mathrm{S}}\right), \mathrm{V}_{\mathrm{D}}=$ output, $\mathrm{V}_{\mathrm{S}}=$ input to off switch.

Table 9. USB related AC electrical characteristics

| Symbol | Parameter | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | Test conditions | Value |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -40 to $85{ }^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  | Min. | Typ. | Max. | Min. | Max. |  |
| ${ }^{\text {tsk }}$ (0) | Channel-tochannel skew | 3.0-3.6 | $C_{L}=10 \mathrm{pF}$ | - | 26 | - | - | - | ps |
| $\mathrm{t}_{\text {SK(P) }}$ | Skew of opposite transition of the same output | 3.0-3.6 | $C_{L}=10 \mathrm{pF}$ | - | 60 | - | - | - | ps |
| TJ | Total jitter | 3.0-3.6 | $\begin{gathered} \mathrm{R}_{\mathrm{L}}=50 \Omega \\ \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} \\ \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=750 \mathrm{ps} \\ \text { at } 480 \mathrm{Mbps} \end{gathered}$ | - | 130 | - | - | - | ps |

## 5 Test circuits

Figure 3. On-resistance


Figure 4. Bandwidth


Figure 5. Off leakage


Figure 6. Channel to channel crosstalk


Figure 7. Off isolation


Figure 8. Test circuit


Note: $\quad C_{L}=5 / 35 \mathrm{pF}$ or equivalent: (includes jig capacitance).
$R_{L}=50 \Omega$ or equivalent.
$R_{T}=Z_{\text {OUT }}$ of pulse generator (typically $50 \Omega$ ).

Figure 9. Break-before-make time delay


Figure 10. Switching time and charge injection ( $\mathrm{V}_{\mathrm{GEN}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{GEN}}=0 \Omega, \mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ )


Figure 11. Turn-on, turn-off delay time


## 6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK ${ }^{\circledR}$ packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 12. Package outline for Flip Chip $30(2.0 \times 2.4 \times 0.625 \mathrm{~mm})-0.4 \mathrm{~mm}$ pitch


Table 10. Mechanical data for Flip Chip $30(2.0 \times 2.4 \times 0.625 \mathrm{~mm})-0.4 \mathrm{~mm}$ pitch

| Symbol | Dimensions (mm) |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |
| A | 0.565 | 0.625 | 0.685 |
| A1 | 0.17 | 0.205 | 0.24 |
| A2 | 0.355 | 0.375 | 0.395 |
| b | 0.215 | 0.255 | 0.295 |
| D | 2.1 | 2.4 | 2.43 |
| D1 | - | 2.0 | - |
| E | 1.97 | 2.0 | 2.03 |
| E1 | - | 1.6 | - |
| e | 0.36 | 0.4 | 0.44 |
| f | 0.19 | 0.2 | 0.21 |
| ccc | - | 0.05 | - |
| $\$$ | 0.040 | 0.045 | 0.05 |

Figure 13. Footprint recommendations for Flip Chip $30(2.0 \times 2.4 \times 0.625 \mathrm{~mm})-0.4 \mathrm{~mm}$ pitch


Figure 14. Tape information for Flip Chip $30(2.0 \times 2.4 \times 0.625 \mathrm{~mm})-0.4 \mathrm{~mm}$ pitch


Figure 15. Reel information for Flip Chip $30(2.0 \times 2.4 \times 0.625 \mathrm{~mm})-0.4 \mathrm{~mm}$ pitch


## 7 Revision history

Table 11. Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 18-Dec-2009 | 1 | Initial release. |
| 19-Jan-2011 | 2 | Document reformatted, added Contents, updated Figure 12 and <br> Figure 13, corrected typo in Features, Table 1, Section 1: Pin <br> settings, Table 2, Table 7, Table 8, notes below Figure 8, title of <br> Figure 11, Figure 12, Table 10, and Figure 13, corrected name <br> of "Table 11" to Figure 13. |
| 23-Apr-2013 | 3 | Moved Description to page 1. <br> Redrawn Figure 1. <br> Updated Section 3 (added/updated cross-references, updated <br> V $_{\text {CC }}$ value in Table 4). <br> Redrawn Figure 12 to Figure 15. <br> Updated Figure 12 (removed superfluous reference to note). <br> Updated title of Figure 14 and Figure 15 (added "Flip Chip 30 <br> (2.0 x 2.4 x 0.625 mm) - 0.4 mm pitch"). <br> Minor corrections throughout document. |
| 06-Aug-2013 | 4 | Updated Table 8 on page 10 (replaced Con and CoFF symbol <br> by C |

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